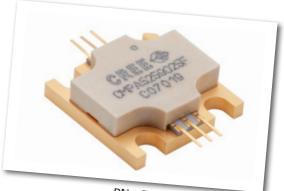


CMPA5259025F

25 W, 5200 - 5900 MHz, 28 V, GaN MMIC for Radar Power Amplifiers

Cree's CMPA5259025F is a gallium nitride (GaN) High Electron Mobility Transistor (HEMT) designed specifically for high efficiency, high gain, and wide bandwidth capabilities, which makes CMPA5259025F ideal for 5.2 - 5.9 GHz Radar amplifier applications. The transistor is supplied in a ceramic/metal flange package.



PN: CMPA5259025F Package Type: 440219

Typical Performance Over 5.2-5.9 GHz ($T_c = 25$ °C) of Demonstration Amplifier

Parameter	5.2 GHz	5.5 GHz	5.9 GHz	Units
Small Signal Gain	33.6	31.9	32.2	dB
Output Power	38.5	39.6	34.8	W
Efficiency	53.5	51.3	47.2	%
Input Return Loss	-13.5	-15.5	-4.8	dB

Note:

100 μsec Pulse Width, 10% Duty Cycle, P_{IN}= 22 dBm

Features

- 30 dB Small Signal Gain
- 50% Efficiency at P_{SAT}
- Operation up to 28 V
- High Breakdown Voltage

Applications

Radar





Absolute Maximum Ratings (not simultaneous) at 25°C Case Temperature

Parameter	Symbol	Rating	Units	Conditions
Drain-source Voltage	$V_{\scriptscriptstyle DSS}$	84	V_{DC}	25°C
Gate-source Voltage	V_{GS}	-10, +2	V_{DC}	25°C
Storage Temperature	T _{STG}	-55, +150	°C	
Operating Junction Temperature	T,	225	°C	
Soldering Temperature	T_s	245	°C	
Screw Torque	τ	60	in-oz	
Forward Gate Current	\mathbf{I}_{e}	8	mA	25°C
Thermal Resistance, Junction to Case ¹	$R_{_{ heta JC}}$	1.66	°C/W	100 usec, 10%, 85°C
Case Operating Temperature	T _c	-40, +105	°C	

Notes:

Electrostatic Discharge (ESD) Classifications

Parameter	Symbol	Class	Test Methodology
Human Body Model	НВМ	1A (> 250 V)	JEDEC JESD22 A114-D
Charge Device Model	CDM	2 (125 V to 250 V)	JEDEC JESD22 C101-C

 $^{^{\}scriptscriptstyle 1}$ Measured for the CMPA5259025F at P $_{\scriptscriptstyle DISS}$ = 35 W.



Electrical Characteristics (T_c = 25°C)

					İ	
Characteristics	Symbol	Min.	Тур.	Max.	Units	Conditions
DC Characteristics¹	· V	2.0	2.5		· ·	V
Gate Threshold Voltage	$V_{GS(th)}$	-3.0	-2.5	-	V _{DC}	$V_{\rm DS}$ = 10 V, $I_{\rm DS}$ = 500 mA
Gate Quiescent Voltage	$V_{GS(Q)}$	-	-2.7	-	V _{DC}	$V_{DS} = 10 \text{ V, } I_{D} = 500 \text{ mA}$
Saturated Drain Current	$\mathbf{I}_{ extsf{DS}}$	16.4	18.6	-	А	$V_{DS} = 6 V$, $V_{GS} = 2 V$
Drain-Source Breakdown Voltage	$V_{\scriptscriptstyle BD}$	84	100	-	V_{DC}	$V_{GS} = -8 \text{ V, } I_{DS} = 500 \text{ mA}$
Case Operating Temperature	T _c	-10		+105	°C	
RF Characteristics ²						
Small Signal Gain ₁	G_{ss}	-	32	-	dB	$V_{_{\mathrm{DD}}} = 28$ V, $I_{_{\mathrm{DQ}}} = 500$ mA, Freq = 5.2 GHz, $P_{_{\mathrm{IN}}} = -20$ dBm
Small Signal Gain ₂	G_{SS}	-	32	-	dB	$V_{_{\mathrm{DD}}} = 28$ V, $I_{_{\mathrm{DQ}}} = 500$ mA, Freq = 5.5 GHz, $P_{_{\mathrm{IN}}} = -20$ dBm
Small Signal Gain ₃	G_{ss}	-	32	-	dB	$V_{_{\mathrm{DD}}} = 28$ V, $I_{_{\mathrm{DQ}}} = 500$ mA, Freq = 5.9 GHz, $P_{_{\mathrm{IN}}} = -20$ dBm
Power Output ₁	P _{out}	-	38.5	-	W	$V_{_{DD}} = 28$ V, $I_{_{DQ}} = 500$ mA, Freq = 5.2 GHz, $P_{_{IN}} = 22$ dBm
Power Output ₂	P _{out}	-	39.6	-	W	$V_{DD} = 28 \text{ V}, I_{DQ} = 500 \text{ mA}, \text{ Freq} = 5.5 \text{ GHz},$ $P_{IN} = 22 \text{ dBm}$
Power Output ₃	P _{out}	÷	34.8	-	W	$V_{DD} = 28 \text{ V}, I_{DQ} = 500 \text{ mA}, \text{ Freq} = 5.9 \text{ GHz},$ $P_{IN} = 22 \text{ dBm}$
Power Added Efficiency ₁	PAE	-	54	-	%	$V_{_{\mathrm{DD}}}$ = 28 V, $I_{_{\mathrm{DQ}}}$ = 500 mA, Freq = 5.2 GHz, $P_{_{\mathrm{IN}}}$ = 22 dBm
Power Added Efficiency ₂	PAE	-	51	-	%	$V_{_{\mathrm{DD}}}$ = 28 V, $I_{_{\mathrm{DQ}}}$ = 500 mA, Freq = 5.5 GHz, $P_{_{\mathrm{IN}}}$ = 22 dBm
Power Added Efficiency ₃	PAE	-	47	-	%	$V_{DD} = 28 \text{ V}, I_{DQ} = 500 \text{ mA}, \text{Freq} = 5.9 \text{ GHz},$ $P_{IN} = 22 \text{ dBm}$
Power Gain ₁	G_p	-	24	-	dB	$V_{DD} = 28$ V, $I_{DQ} = 500$ mA, Freq = 5.2 GHz, $P_{IN} = 22$ dBm
Power Gain ₂	G_{p}	-	24	-	dB	$V_{_{\mathrm{DD}}} = 28$ V, $I_{_{\mathrm{DQ}}} = 500$ mA, Freq = 5.5 GHz, $P_{_{\mathrm{IN}}} = 22$ dBm
Power Gain ₃	G_p	-	23.4	-	dB	$V_{_{\mathrm{DD}}}$ = 28 V, $I_{_{\mathrm{DQ}}}$ = 500 mA, Freq = 5.9 GHz, $P_{_{\mathrm{IN}}}$ = 22 dBm
Input Return Loss	S11	-	-10	-	dB	$V_{_{\mathrm{DD}}}$ = 28 V, $I_{_{\mathrm{DQ}}}$ = 500 mA, Freq = 5.2 - 5.9 GHz, $P_{_{\mathrm{IN}}}$ = -20 dBm
Output Return Loss	S22	-	-15	-	dB	$V_{DD} = 28$ V, $I_{DQ} = 500$ mA, Freq = 5.2 - 5.9 GHz, $P_{IN} = -20$ dBm
Output Mismatch Stress	VSWR	-	3:1	-	Ψ	No damage at all phase angles, $V_{DD} = 28 \text{ V}$, $I_{DQ} = 500 \text{ mA}$, $P_{IN} = 22 \text{ dBm}$

Notes

¹ Measured on wafer prior to packaging.

² Measured in CMPA5259025F-TB test fixture.

 $^{^{3}}$ Drain Efficiency = P_{OUT}/P_{DC}



Typical Pulsed Performance of the CMPA5259025F

Figure 1. - Gain and Input Return Loss vs. Frequency of the CMPA5259025F Measured in CMPA5259025F-AMP Amplifier Circuit $V_{DD}=28~V,~I_{DO}=0.5~A,~T_{C}=25^{\circ}C$

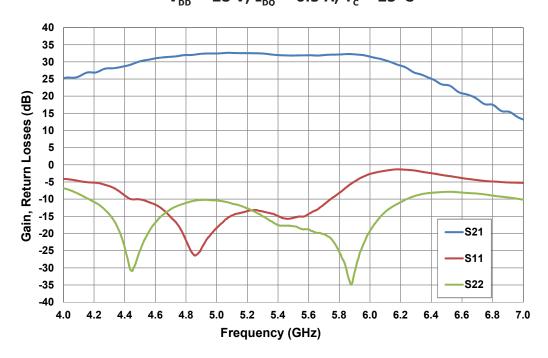
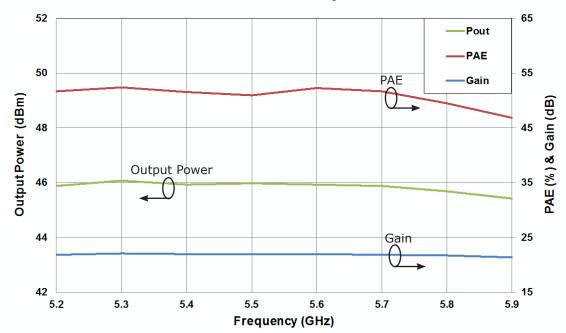


Figure 2. - Output Power, Gain, and Power Added Efficiency vs. Frequency of the CMPA5259025F Measured in CMPA525025F-AMP Amplifier Circuit $V_{DD}=28~V,~I_{DQ}=0.5~A,~P_{IN}=24~dBm,~Pulse~Width=100~\mu s,~Duty~Cycle=10\%,~T_c=25°C$

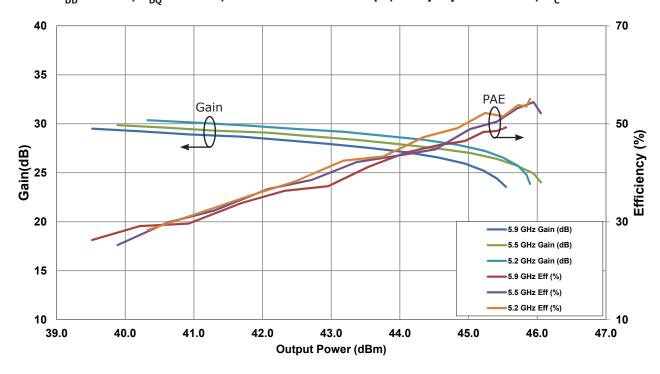


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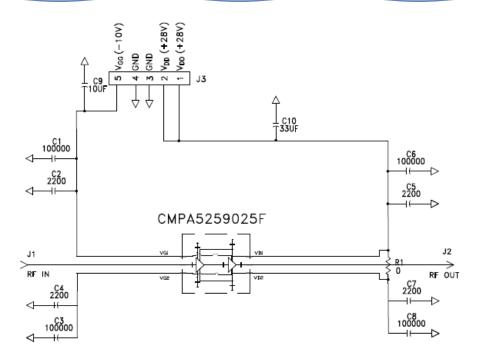
Typical Pulsed Performance of the CMPA5259025F

Figure 3. - Gain and Power Added Efficiency vs. Frequency of the CMPA529025F Measured in CMPA525025F-AMP Amplifier Circuit $V_{DD}=28~V,~I_{DO}=0.5~A,~Pulse~Width=100~\mu s,~Duty~Cycle=10\%,~T_c=25^{\circ}C$

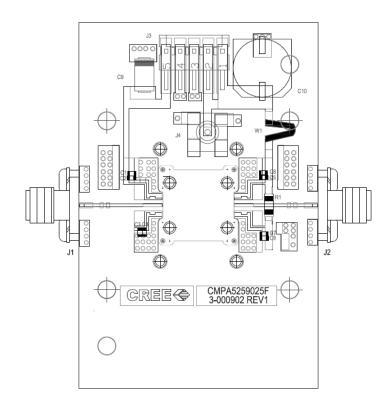




CMPA5259025F-TB Demonstration Amplifier Schematic



CMPA5259025F-TB Demonstration Amplifier Circuit Outline





CMPA5259025F-TB Demonstration Amplifier Circuit Bill of Materials

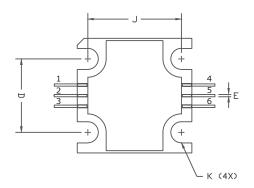
Designator	Description	Qty
R1	RES 0 OHM, SMT, 1206, 125 mW	1
C1, C3, C6, C8	CAP, 100000 pF, (0.1 UF) +/- 10%, 100 V, 0805	4
C2, C4, C5, C7	CAP, 0805, 2200 pF, 100 V, 0805	4
C9	CAP, 10 UF, 16 V, Tantalum	1
C10	CAP, 33 UF, 20%, G Case	1
Ј3	Header RT> PLZ .1 CEN LK 5POS	1
J1, J2	CONN, SMA, Female, 2-Hole, Flange	2
J4	CONN, SMB, Straight Jack Receptacle, SMT, 50 OHM, Au Plated	1
	Baseplate, AL, 2.60 X 1.7 X 0.25	
	#4 Split Lockwasher SS	4
	2-56 SoC HD Screw 3/16 SS	4
	#2 Split Lockwasher SS	
	4-40 SOC HD Screw 3/8" SS	
	PCB, Taconics, RF 35, CMPA5259025F 0.010" THK	
W1	Wire, Black, 22 AWG ~ 3"	

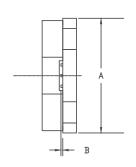
CMPA5259025F-TB Demonstration Amplifier Circuit

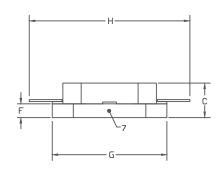


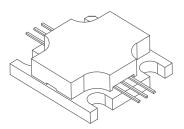


Product Dimensions CMPA5259025F (Package Type - 440219)









NOT TO SCALE

PIN	
1	Gate bias
2	RF_{IN}
3	Gate bias
4	Drain bias
5	RF _{OUT}
6	Drain bias
7	Source

NOTES

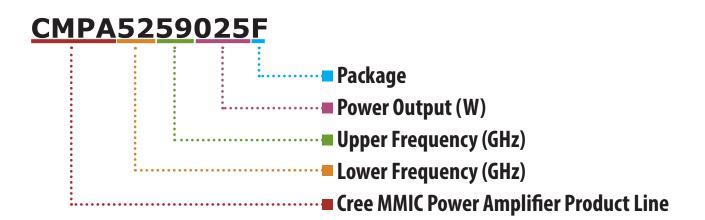
- 1. DIMENSIONING AND TOLERANICING PER ANSI Y14.5M, 1982.
- 2. CONTROLLING DIMENSION: INCH.
- 3. ADHESIVE FROM LID MAY EXTEND A MAXIMUM OF 0.020" BEYOND EDGE OF LID.
- 4. LID MAY BE MISALIGNED TO THE BODY OF THE PACKAGE BY A MAXIMUM OF 0.008" IN ANY DIRECTION.
- 5. ALL PLATED SURFACES ARE NI/AU

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.495	0.505	12.57	12.82
В	0.007	0.009	0.178	0.229
С	0.140	0.160	3.56	4.06
D	0.315	0.325	8.00	8.25
E	0.009	0.011	0.229	0.279
F	0.055	0.065	1.40	1.65
G	0.495	0.505	12.57	12.82
Н	0.695	0.705	17.65	17.91
J	0.403	0.413	10.24	10.49
K	ø .092		2.3	34

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Part Number System



Parameter	Value	Units
Lower Frequency	5.2	GHz
Upper Frequency ¹	5.9	GHz
Power Output	25	W
Package	Flange	-

Table 1.

Note¹: Alpha characters used in frequency code indicate a value greater than 9.9 GHz. See Table 2 for value.

Character Code	Code Value
А	0
В	1
С	2
D	3
E	4
F	5
G	6
Н	7
J	8
K	9
Examples:	1A = 10.0 GHz 2H = 27.0 GHz

Table 2.



Product Ordering Information

Order Number	Description	Unit of Measure	Image
CMPA5259025F	GaN MMIC	Each	C. C
CMPA5259025F-AMP	Test board with GaN MMIC installed	Each	



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